

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|---|---|------------------|---------|------------------|
| L2 | 167 | hongo-akihisa.in. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/02/28 16:23 |
| L3 | 14 | morisawa-shinya.in. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/02/28 16:23 |
| L4 | 917 | plat\$4 same etch\$4 same (copper or Cu or silver) same (peripheral or edge or circumference) | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/02/28 16:28 |
| L5 | 539 | clean\$4 same (copper or Cu) same (peripheral or edge or circumference) | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/02/28 16:25 |
| L6 | 293 | clean\$4 same etch\$4 same (copper or Cu) same (peripheral or edge or circumference) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/02/28 16:26 |
| L7 | 855 | plat\$4 same etch\$4 same (copper or Cu) same (peripheral or edge or circumference) | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/02/28 16:26 |
| L8 | 25 | etch\$4 same (copper or Cu or silver or Au or gold) same (peripheral or edge or circumference) same (residues or contaminations) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/02/28 16:29 |
| L9 | 2933 | etch\$4 and (copper or Cu or silver or Au or gold) and (peripheral or edge or circumference) and (residues or contaminations) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/02/28 16:29 |
| L10 | 827 | @py<="2000" and 9 | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/02/28 16:30 |
| L11 | 415 | 10 and semiconductor | USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/02/28 16:30 |